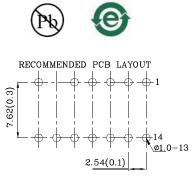


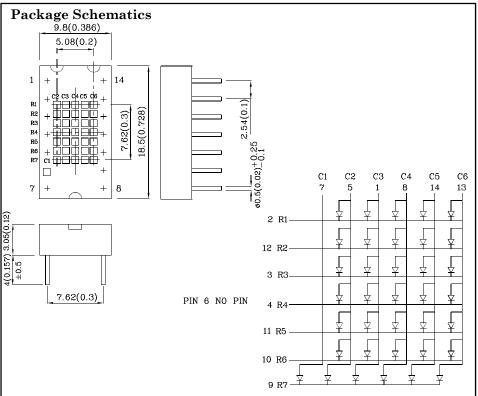
## Part Number: XMUY07A

7.62mm (0.3 ") SINGLE COLOR DOT MATRIX DIS-PLAY

#### Features

- $\bullet$  Low power consumption
- $\bullet$  Robust package
- I.C. Compatible
- Optional black face provides superior color contrast
- RoHS Compliant





Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01")$ unless otherwise noted. 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		UY (GaAsP/GaP)	Unit	
Reverse Voltage	$V_{R}$	5	V	
Forward Current	$I_{\rm F}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	$P_{D}$	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	-40 ~ +85		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3-5 Seconds			

Operating Characteristics (T <sub>A</sub> =25°C)		UY (GaAsP/GaP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\rm F}$	1.95	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	2.5	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	I <sub>R</sub> 10	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λP	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	588*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$ riangle\lambda$	35	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	$_{ m pF}$

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (IF=10mA) ucd		Wavelength CIE127-2007* nm λΡ	Description
			min.	typ.		
XMUY07A	Yellow	GaAsP/GaP	3600 1400*	7890 2490*	590*	Column Anode

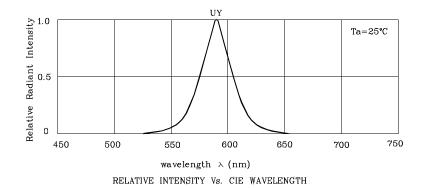
 ${\rm *Luminous\ intensity\ value\ and\ wavelength\ are\ in\ accordance\ with\ CIE127-2007\ standards.}$ 

Mar 04,2014

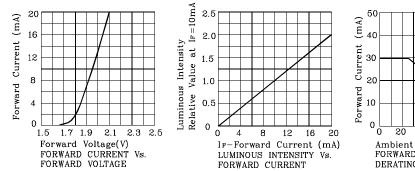
XDSA1811 V7-X Layout: Maggie L.

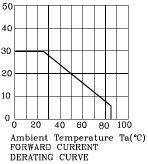


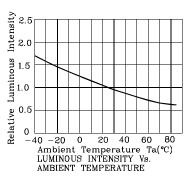
# Part Number: XMUY07A 7.62mm (0.3 ") SINGLE COLOR DOT MATRIX DIS-PLAY



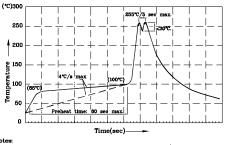
♦ UY







Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



Access I.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max)

Peak wave soldering temperature between 2+30 - 2+30

Remarks:

If special sorting is required (e.g. binning based on forward voltage,

luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

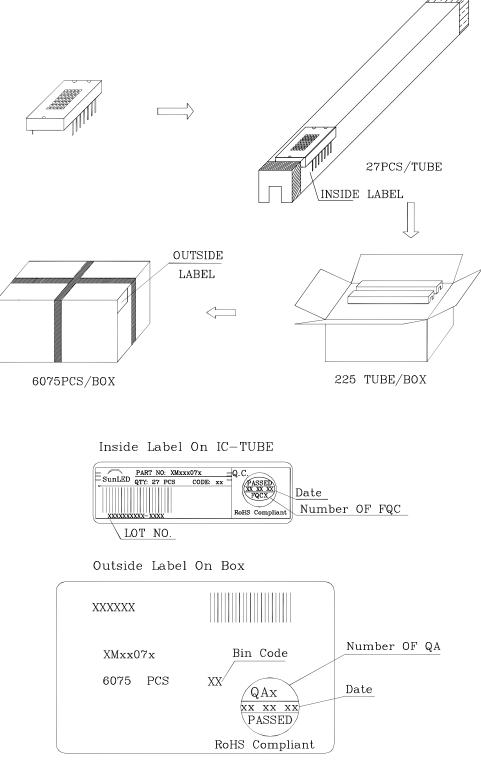
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V
- Note: Accuracy may depend on the sorting parameters.



## Part Number: XMUY07A

7.62mm (0.3 ") SINGLE COLOR DOT MATRIX DIS-PLAY

#### **PACKING & LABEL SPECIFICATIONS**



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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
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